

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of )  
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Sakama et al.         )  
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Serial No.:            )  
                          )  
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Filed: Herewith        )  
                          )  
                          )  
For:    Semiconductor Device And        )  
        A Method Of Manufacturing The Same)     )  
                          )  
Art Unit:              )  
                          )  
Examiner:             )

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Name: Yue X. Luan  
(typed or printed)

Signature Yue X. Luan

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT A**

Sir:

Prior to examination and calculation of fees, please enter the following amendment in the above-identified application: